



RoHS Compliant

**MAX  
260°C**

**MSL  
1**



PRODUCT FAMILY	Material	CAS Number	% Normalize for BOM	Wt. Of BOM Item (g)	% by Wt (Comp. Item)	mg/unit	% by Wt Of Unit 225.90	ppm
752 10 SRT	Alumina Ceramic	Al2O3	0.8800	0.1988	87.50%	173.9430	77.00%	770000
		SiO2 (silicon dioxide)			12.50%	24.8490	11.00%	110000
					<b>100.00%</b>	<b>198.7920</b>		
	Conductor Thick Film	Ag	0.0068	0.0015	100.00%	1.5361	0.68%	6800
					<b>100.00%</b>	<b>1.5361</b>		
	Resistor Thick Film	RuO2	0.0079	0.0018	30.00%	0.5354	0.24%	2370
		PbO			10.00%	0.1785	0.08%	790
		SiO2 (silicon dioxide)			30.00%	0.5354	0.24%	2370
		B2O3			30.00%	0.5354	0.24%	2370
					<b>100.00%</b>	<b>1.7846</b>		
	Notch Conductor Thick Film	Ag	0.0113	0.0026	100.00%	2.5527	1.13%	11300
					<b>100.00%</b>	<b>2.5527</b>		
	Underplate	Ni	0.0250	0.0056	100.00%	5.6475	2.50%	25000
					<b>100.00%</b>	<b>5.6475</b>		
	Finish Plate	Sn	0.0170	0.0038	100.00%	3.8403	1.70%	17000
					<b>100.00%</b>	<b>3.8403</b>		
	Covercoat	TiO2	0.0520	0.0117	50.00%	5.8734	2.60%	26000
		Silicone			50.00%	5.8734	2.60%	26000
		Sum	1.0000	0.2259	<b>100.00%</b>	<b>11.7468</b>		
			part weight	0.2259				
		<b>Totals:</b>		<b>0.2259</b>		<b>225.90</b>	<b>100.00%</b>	<b>1000000</b>

RoHS exemption claimed for lead in glass of electronic component